

To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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Notice

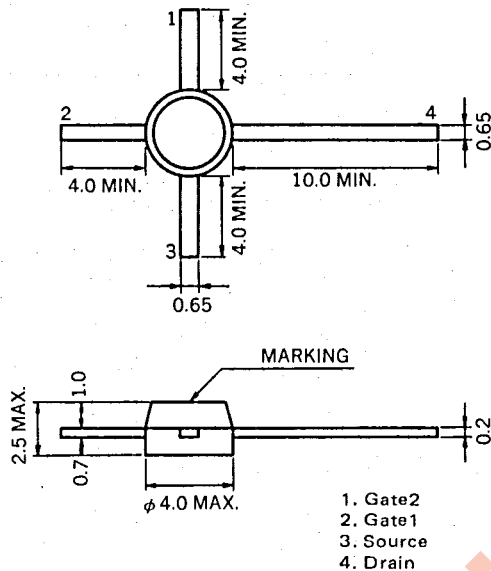
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RF AMP. FOR UHF TV TUNER
N-CHANNEL GaAs DUAL GATE MES FIELD-EFFECT TRANSISTOR
4PIN MINI MOLD

PACKAGE DIMENSIONS
in millimeters



FEATURES

- Suitable for use as RF amplifier in UHF TV tuner.
- Low C_{RSS} : 0.02 pF TYP.
- High G_{PS} : 20 dB TYP.
- Low NF : 1.1 dB TYP.

ABSOLUTE MAXIMUM RATINGS ($T_a = 25^\circ\text{C}$)

Drain to Source Voltage	V_{DSX}	10	V
Gate1 to Source Voltage	V_{G1S}	-4.5	V
Gate2 to Source Voltage	V_{G2S}	-4.5	V
Drain Current	I_D	80	mA
Total Power Dissipation	P_T	200	mW
Channel Temperature	T_{ch}	125	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 to +125	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source Breakdown Voltage	BV_{DSX}	10			V	$V_{G1S} = -4\text{ V}, V_{G2S} = 0, I_D = 20\ \mu\text{A}$
Drain Current	I_{DSS}	10		80	mA	$V_{DS} = 5\text{ V}, V_{G1S} = 0, V_{G2S} = 0$
Gate1 to Source Cutoff Voltage	$V_{G1S(off)}$			-3.5	V	$V_{DS} = 5\text{ V}, V_{G2S} = 0, I_D = 100\ \mu\text{A}$
Gate2 to Source Cutoff Voltage	$V_{G2S(off)}$			-3.5	V	$V_{DS} = 5\text{ V}, V_{G1S} = 0, I_D = 100\ \mu\text{A}$
Gate1 Reverse Current	I_{G1SS}			10	μA	$V_{DS} = 0, V_{G1S} = -4\text{ V}, V_{G2S} = 0$
Gate2 Reverse Current	I_{G2SS}			10	μA	$V_{DS} = 0, V_{G2S} = -4\text{ V}, V_{G1S} = 0$
Forward Transfer Admittance	$ y_{fs} $	25	35		mS	$V_{DS} = 5\text{ V}, V_{G2S} = 1\text{ V}, I_D = 10\text{ mA}, f = 1.0\text{ kHz}$
Input Capacitance	C_{iss}	1.0	1.5	2.0	pF	$V_{DS} = 5\text{ V}, V_{G2S} = 1\text{ V}, I_D = 10\text{ mA}, f = 1.0\text{ MHz}$
Reverse Transfer Capacitance	C_{rss}		0.02	0.035	pF	
Power Gain	G_{PS}	16.0	20.0		dB	$V_{DS} = 5\text{ V}, V_{G2S} = 1\text{ V}, I_D = 10\text{ mA}, f = 900\text{ MHz}$
Noise Figure	NF		1.1	2.5	dB	

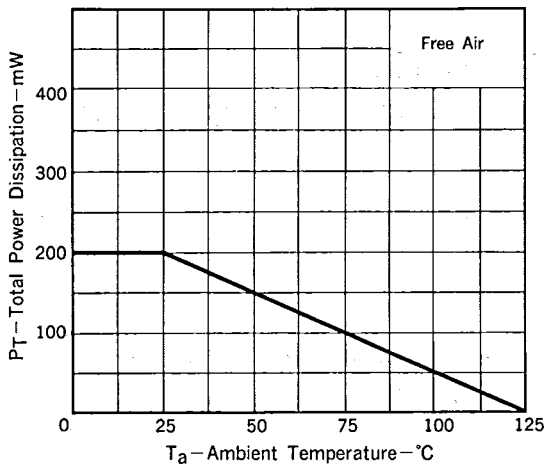
I_{DSS} Classification (Unit: mA)

Marking	N	M	L	K
I_{DSS}	10 to 25	20 to 35	30 to 50	45 to 80

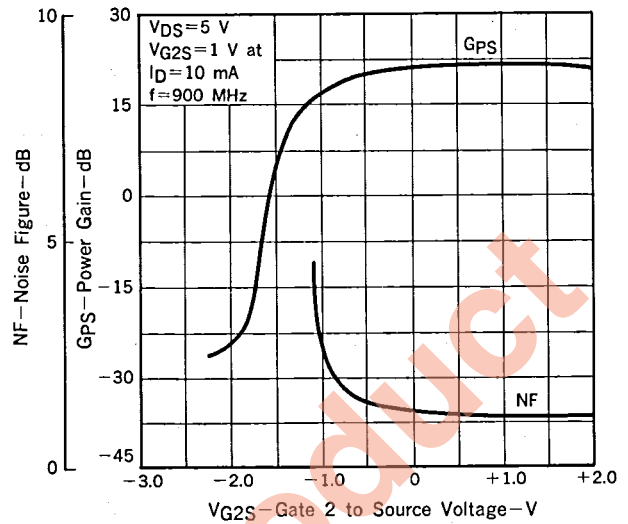
PRECAUTION: Avoid high static voltages or electric fields so that this device would not suffer from any damage due to those voltage or fields.

TYPICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)

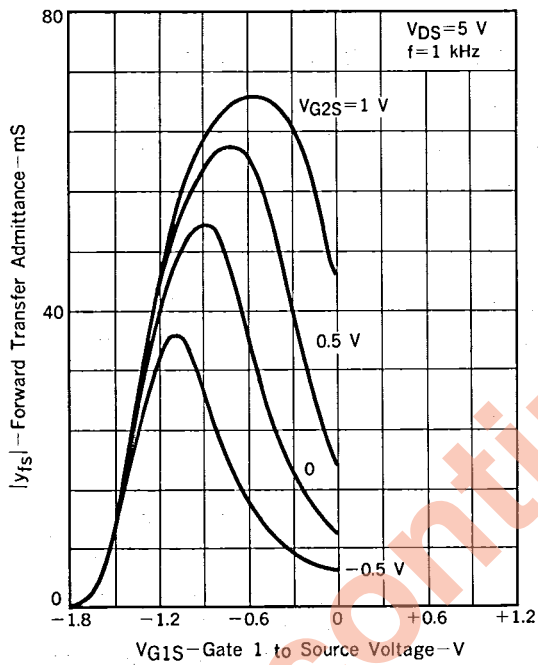
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



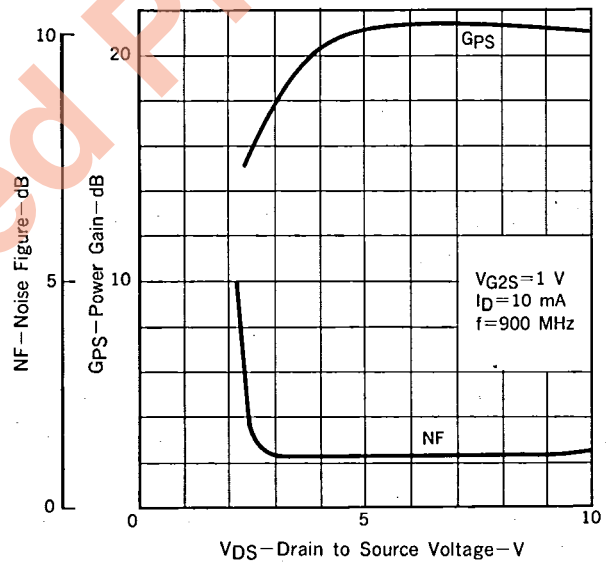
POWER GAIN AND NOISE FIGURE vs. GATE2 TO SOURCE VOLTAGE



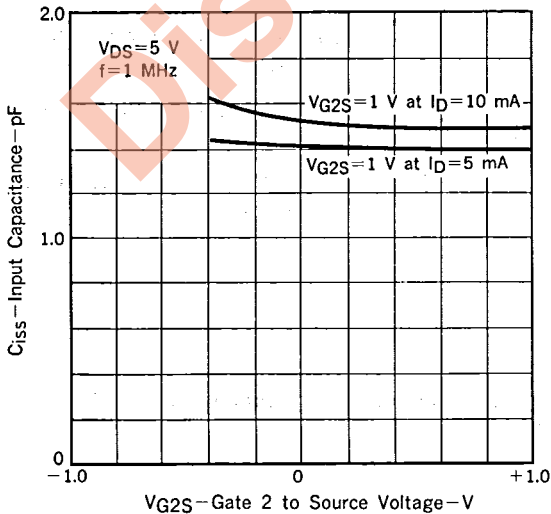
FORWARD TRANSFER ADMITTANCE vs. GATE1 TO SOURCE VOLTAGE



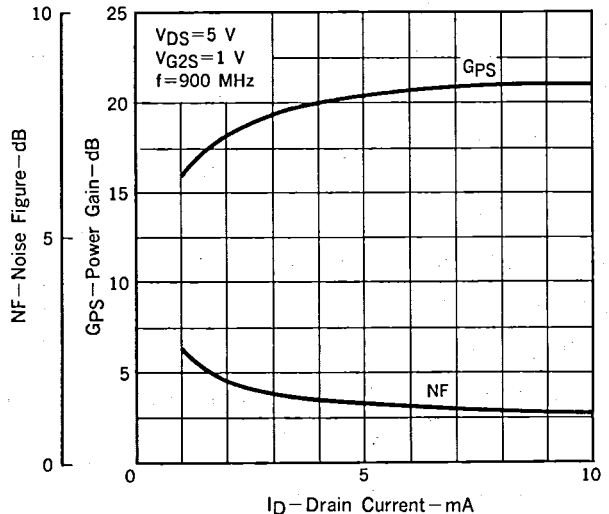
POWER GAIN AND NOISE FIGURE vs. DRAIN TO SOURCE VOLTAGE



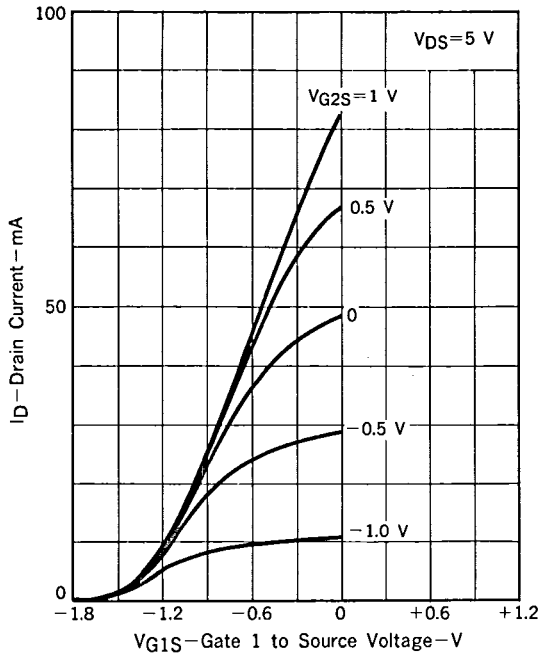
INPUT CAPACITANCE vs. GATE2 TO SOURCE VOLTAGE



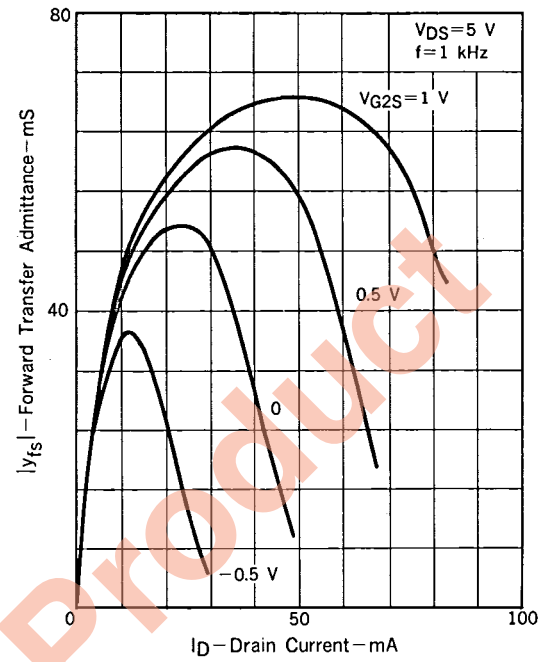
POWER GAIN AND NOISE FIGURE vs. DRAIN CURRENT



DRAIN CURRENT vs. GATE1 TO SOURCE VOLTAGE



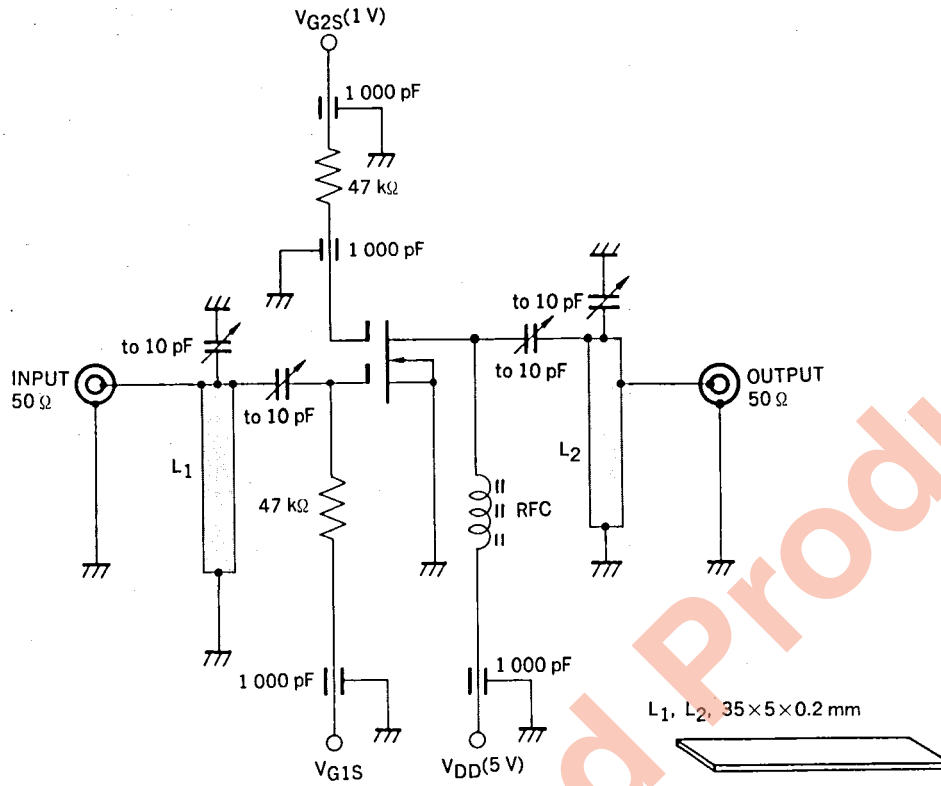
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



S-PARAMETER ($V_{DS} = 5 V, V_{G2S} = 1 V, I_D = 10 mA$)

FREQUENCY (MHz)	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
100.00	1.006	-4.1	4.218	174.4	0.004	97.3	0.957	-2.2
200.00	0.979	-9.6	4.253	162.2	0.002	11.1	0.944	-4.7
300.00	0.973	-12.4	4.065	156.2	0.005	82.6	0.954	-6.0
400.00	0.939	-18.2	3.944	148.2	0.007	92.1	0.952	-9.4
500.00	0.902	-19.7	3.854	145.7	0.005	79.3	0.944	-9.9
600.00	0.879	-26.0	4.068	135.0	0.007	68.6	0.963	-14.4
700.00	0.815	-26.8	3.734	127.2	0.006	95.3	0.938	-14.1
800.00	0.805	-31.9	3.727	120.3	0.009	92.8	0.958	-18.3
900.00	0.747	-33.0	3.586	115.4	0.007	109.8	0.939	-19.5
1000.00	0.743	-36.3	3.770	108.8	0.009	140.9	0.988	-23.4
1100.00	0.678	-36.7	3.574	99.4	0.007	172.7	0.955	-24.9
1200.00	0.703	-37.4	3.573	93.9	0.012	-147.6	1.040	-27.8

900 MHz G_{PS} AND NF TEST CIRCUIT



$V_{DS} = 5\ V, V_{GS} = 1\ V, I_D = 10\ mA$

